



**THE DATASHEET OF
DMTH15H017LPSWQ-13**



Product Summary

| BV _{bss} | R _{DS(ON)} Max | I _D Max T _c = +25°C |
|-------------------|---------------------------------|--|
| 150V | 17.5mΩ @ V _{GS} = 10V | 50A |
| | 25.5mΩ @ V _{GS} = 4.5V | 43A |

Description and Applications

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switch.

- Synchronous rectification
- Power switching
- Class D audio amplifiers

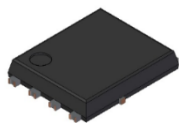
Features

- Rated to +175°C – Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production – Ensures More Reliable and Robust End Application
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} – Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile – Ideal for Thin Applications (PowerDI®)
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. “Green” Device (Note 3)**
- **The DIODES™ DMTH15H017LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**
<https://www.diodes.com/quality/product-definitions/>

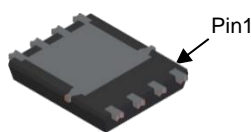
Mechanical Data

- Package: PowerDI5060-8
- Package Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.097 grams (Approximate)

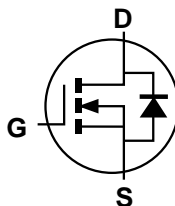
PowerDI5060-8 (SWP) (Type UX)



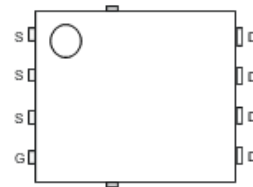
Top View



Bottom View



Internal Schematic



Top View
Pin Configuration

Ordering Information (Note 4)

| Part Number | Package | Packing | |
|--------------------|-------------------------------|---------|-------------|
| | | Qty. | Carrier |
| DMTH15H017LPSWQ-13 | PowerDI5060-8 (SWP) (Type UX) | 2,500 | Tape & Reel |

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



D D D D = Manufacturer's Marking
 TH1517LSW = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 22 = 2022)
 WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Unit |
|---|--------------|-------------------------|------------------|-------|------|
| Drain-Source Voltage | | | V _{DSS} | 150 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| Continuous Drain Current V _{GS} = 10V (Note 5) | Steady State | T _A = +25°C | I _D | 8 | A |
| | | T _A = +100°C | | 5.7 | |
| Continuous Drain Current V _{GS} = 10V (Note 6) | Steady State | T _C = +25°C | I _D | 50 | A |
| | | T _C = +100°C | | 35 | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | I _{DM} | 200 | A |
| Maximum Continuous Body Diode Forward Current | | | I _S | 50 | A |
| Pulsed Body Diode Current (10µs Pulse, Duty Cycle = 1%) | | | I _{SM} | 200 | A |
| Avalanche Current (Note 7), L = 3mH | | | I _{AS} | 14.5 | A |
| Avalanche Energy (Note 7), L = 3mH | | | E _{AS} | 315.4 | mJ |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|--|------------------------|-----------------------------------|-------------|------|
| Total Power Dissipation (Note 8) | T _A = +25°C | P _D | 1.5 | W |
| Thermal Resistance, Junction to Ambient (Note 8) | Steady State | R _{θJA} | 99 | °C/W |
| Total Power Dissipation (Note 5) | T _A = +25°C | P _D | 2.8 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | R _{θJA} | 53 | °C/W |
| Total Power Dissipation (Note 6) | T _C = +25°C | P _D | 107 | W |
| Thermal Resistance, Junction to Case (Note 6) | | R _{θJC} | 1.4 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +175 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--|---------------------|-----|------|------|------|---|
| OFF CHARACTERISTICS (Note 9) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 150 | — | — | V | V _{GS} = 0V, I _D = 10mA |
| Zero Gate Voltage Drain Current | I _{DSS} | — | — | 1 | µA | V _{DS} = 120V, V _{GS} = 0V |
| Gate-Source Leakage | I _{GSS} | — | — | ±100 | nA | V _{GS} = ±20V, V _{DS} = 0V |
| ON CHARACTERISTICS (Note 9) | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | 1.3 | — | 2.6 | V | V _{DS} = V _{GS} , I _D = 250µA |
| Static Drain-Source On-Resistance | R _{DS(ON)} | — | 13 | 17.5 | mΩ | V _{GS} = 10V, I _D = 20A |
| | | — | 17 | 25.5 | | V _{GS} = 4.5V, I _D = 20A |
| Diode Forward Voltage | V _{SD} | — | 0.8 | 1.2 | V | V _{GS} = 0V, I _S = 20A |
| DYNAMIC CHARACTERISTICS (Note 10) | | | | | | |
| Input Capacitance | C _{iss} | — | 3369 | — | pF | V _{DS} = 75V, V _{GS} = 0V f = 1MHz |
| Output Capacitance | C _{oss} | — | 211 | — | | |
| Reverse Transfer Capacitance | C _{rss} | — | 6.7 | — | | |
| Gate Resistance | R _g | — | 1.9 | — | Ω | V _{DS} = 0V, V _{GS} = 0V, f = 1MHz |
| Total Gate Charge | Q _g | — | 50 | — | nC | V _{DD} = 75V, I _D = 20A V _{GS} = 10V |
| Gate-Source Charge | Q _{gs} | — | 12.8 | — | | |
| Gate-Drain Charge | Q _{gd} | — | 9.4 | — | | |
| Turn-On Delay Time | t _{D(ON)} | — | 10.5 | — | ns | V _{DD} = 75V, V _{GS} = 10V I _D = 20A, R _g = 6Ω |
| Turn-On Rise Time | t _r | — | 16.3 | — | | |
| Turn-Off Delay Time | t _{D(OFF)} | — | 44.6 | — | | |
| Turn-Off Fall Time | t _f | — | 17.7 | — | | |
| Reverse Recovery Time | t _{RR} | — | 72 | — | ns | I _F = 20A, di/dt = 100A/µs |
| Reverse Recovery Charge | Q _{RR} | — | 215 | — | nC | |

- Notes:
- Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 - Thermal resistance from junction to soldering point (on the exposed drain pad).
 - I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 - Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 - Short duration pulse test used to minimize self-heating effect.
 - Guaranteed by design. Not subject to product testing.

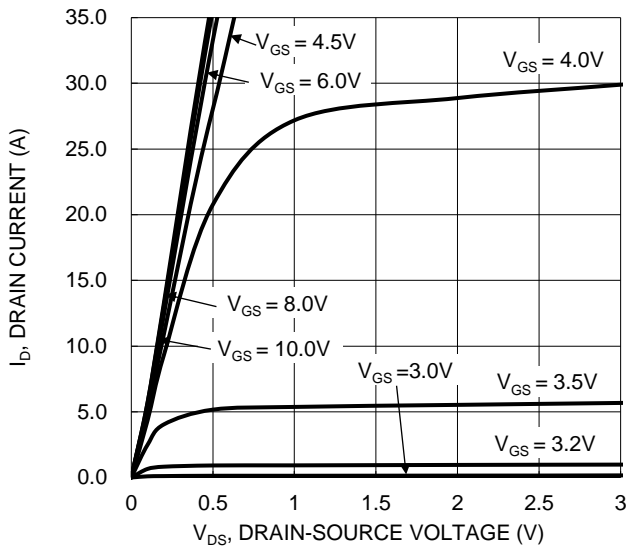


Figure 1. Typical Output Characteristic

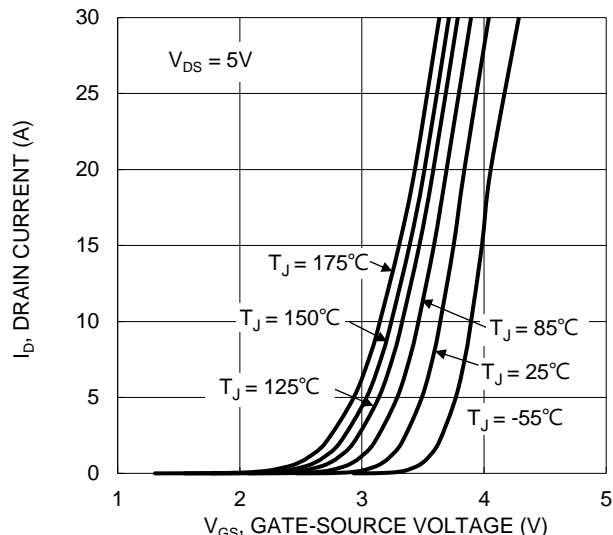


Figure 2. Typical Transfer Characteristic

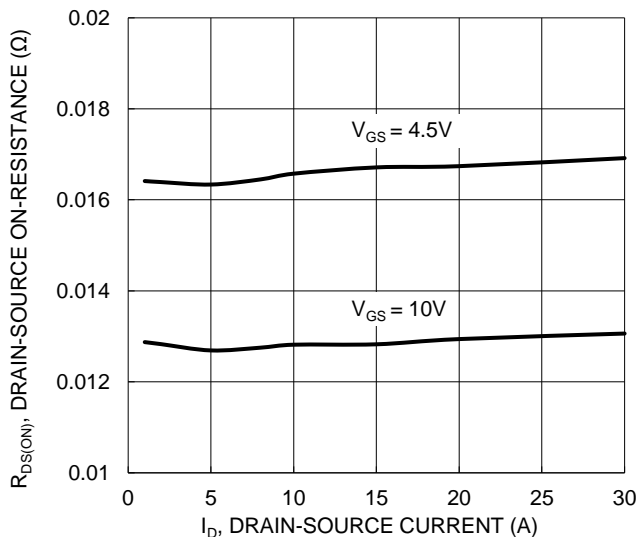


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

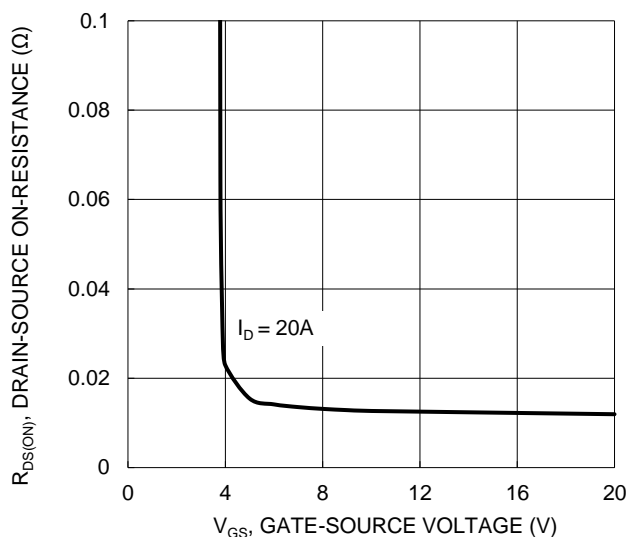


Figure 4. Typical Transfer Characteristic

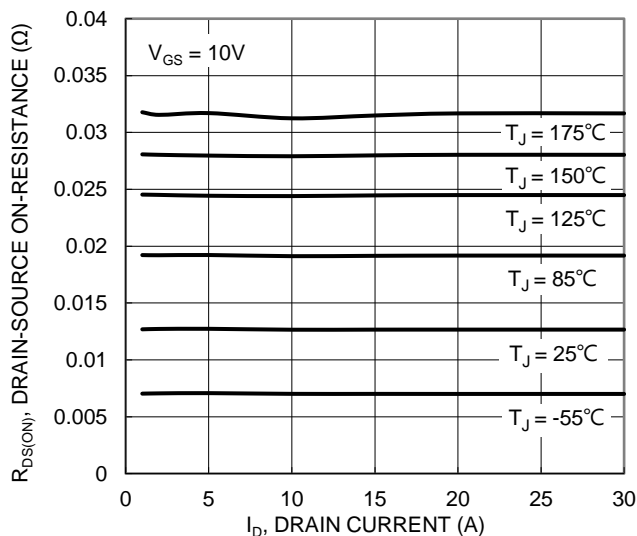


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

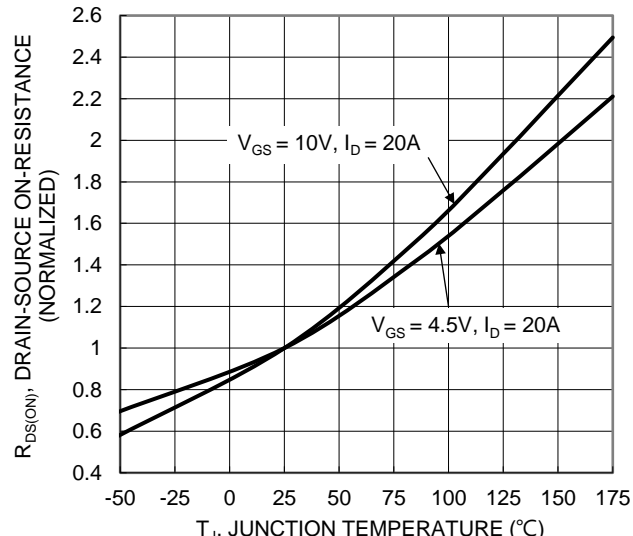


Figure 6. On-Resistance Variation with Junction Temperature

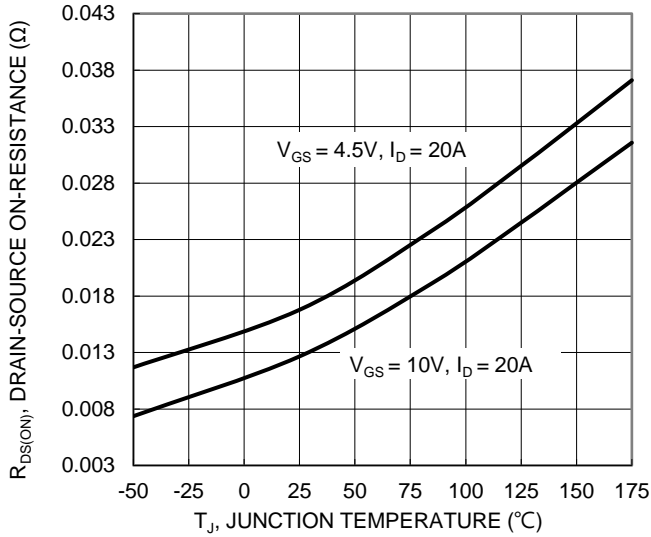


Figure 7. On-Resistance Variation with Junction Temperature

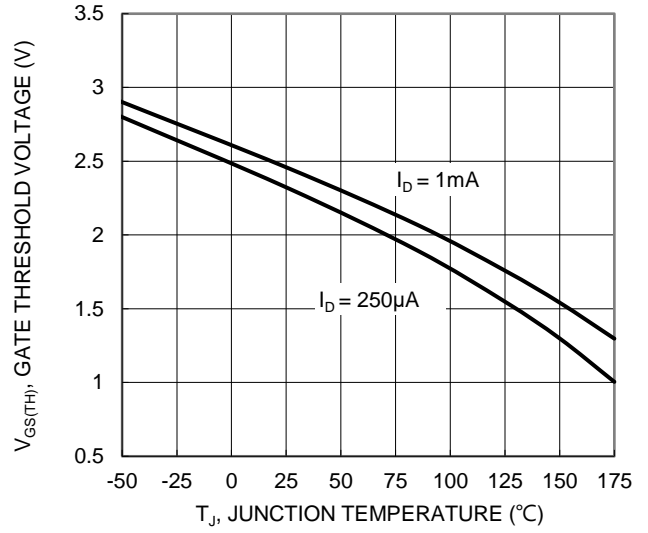


Figure 8. Gate Threshold Variation vs. Junction Temperature

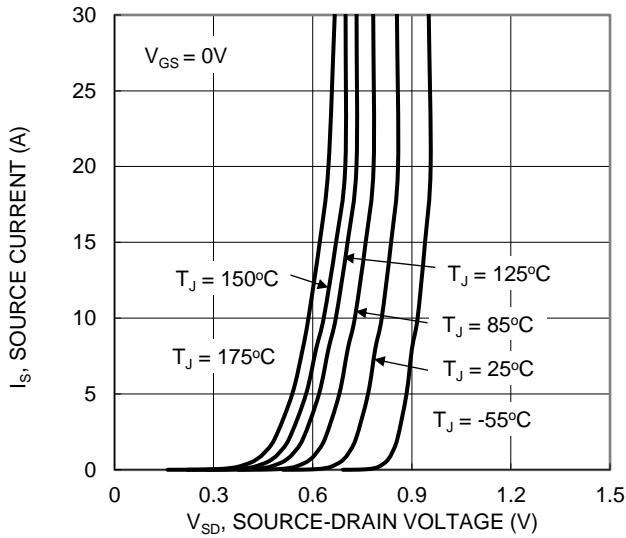


Figure 9. Diode Forward Voltage vs. Current

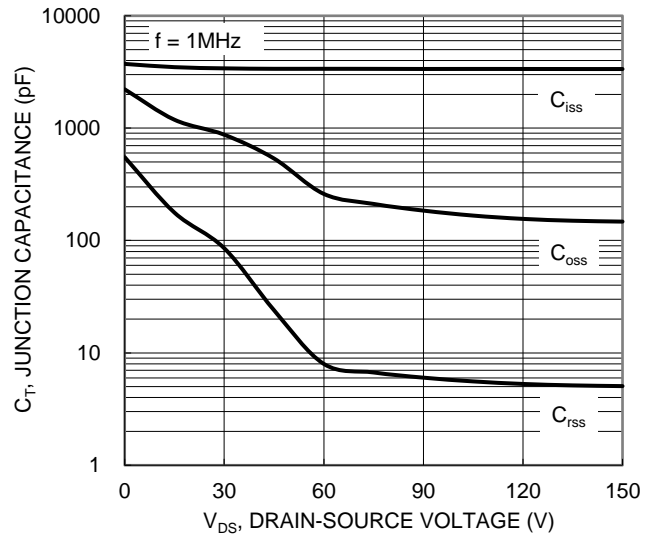


Figure 10. Typical Junction Capacitance

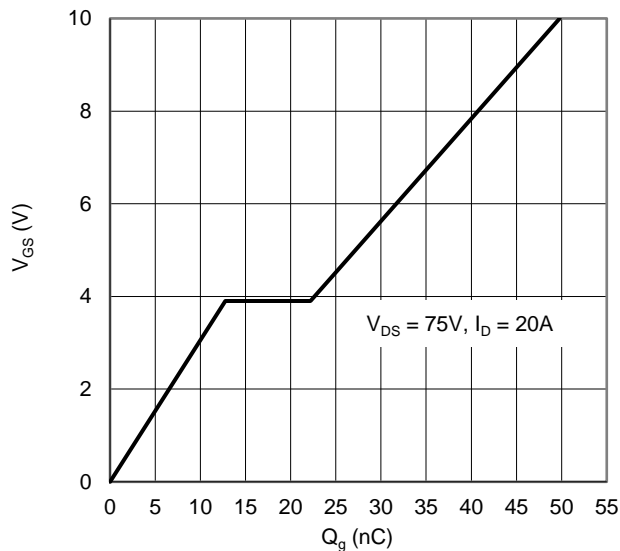


Figure 11. Gate Charge

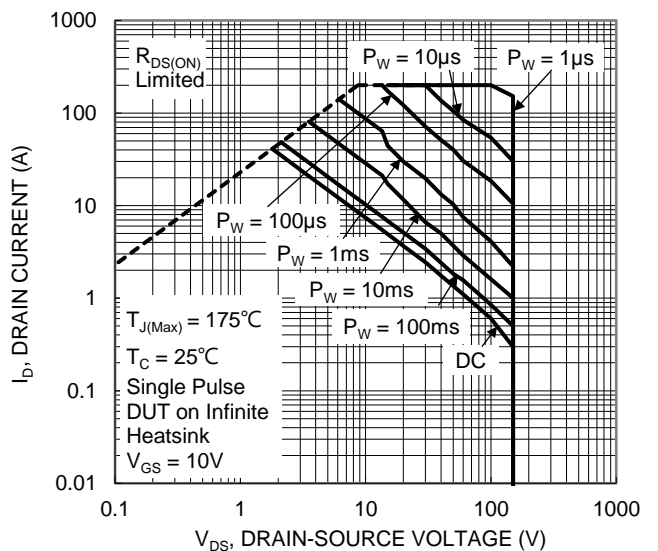


Figure 12. SOA, Safe Operation Area

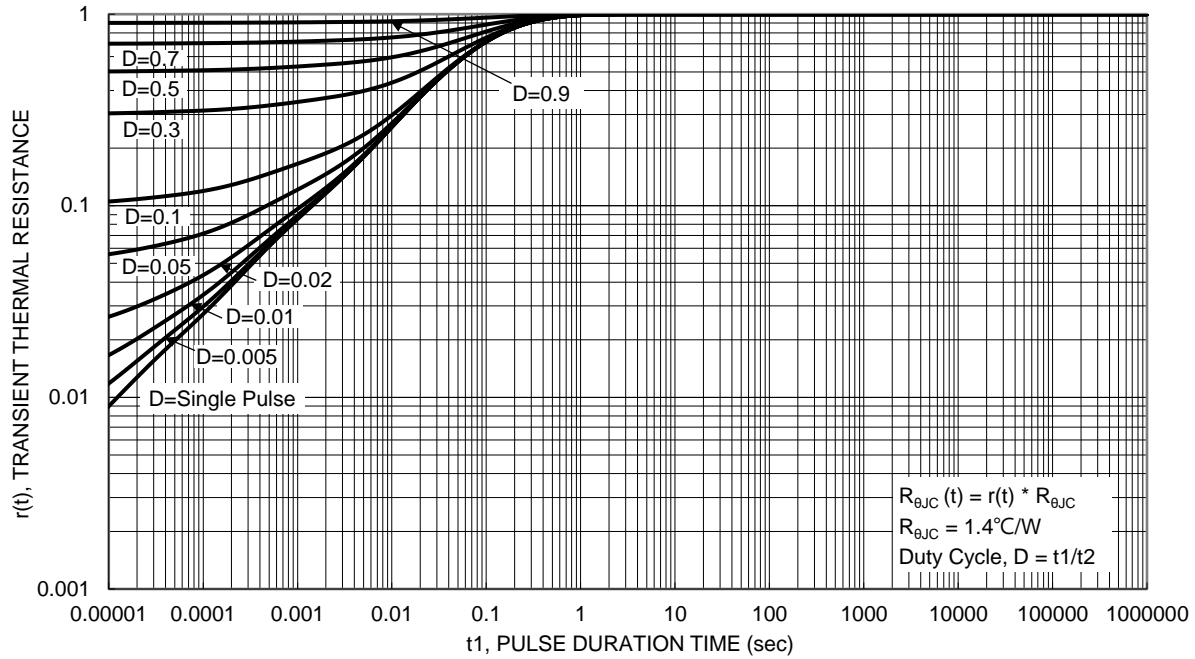
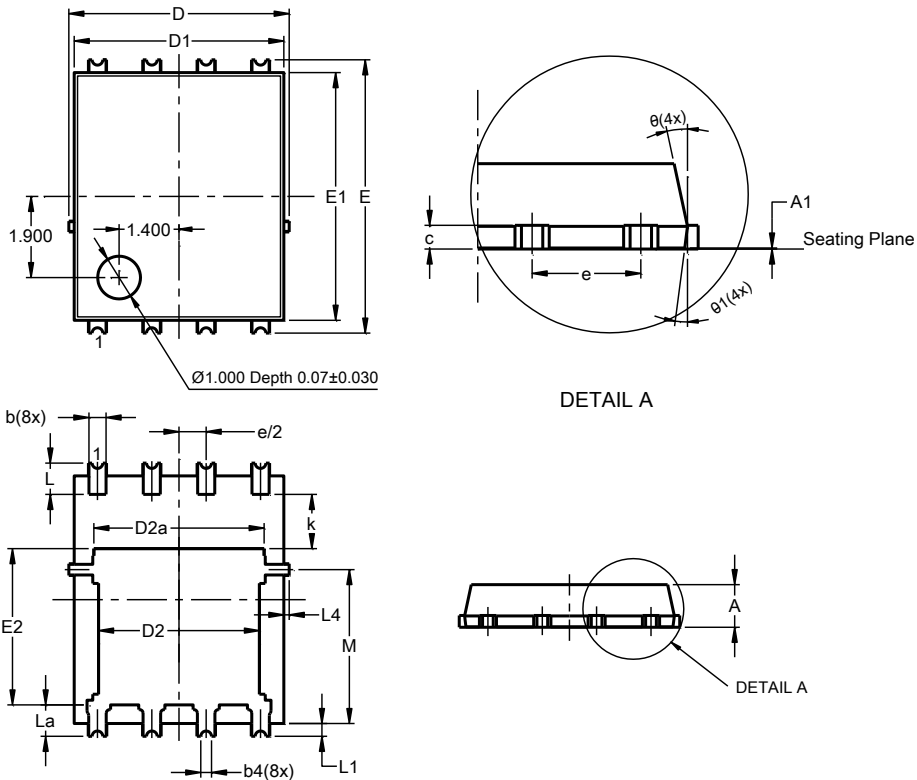


Figure 13. Transient Thermal Resistance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5060-8 (SWP) (Type UX)

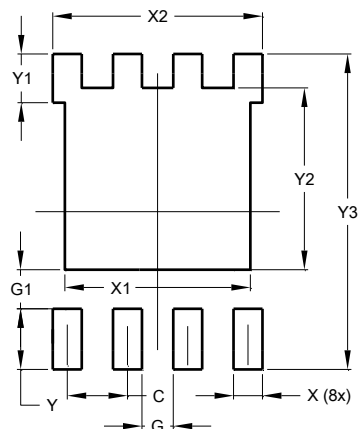


| PowerDI5060-8 (SWP) (Type UX) | | | |
|----------------------------------|----------|-------|-------|
| Dim | Min | Max | Typ |
| A | 0.90 | 1.10 | 1.00 |
| A1 | 0 | 0.05 | -- |
| b | 0.30 | 0.50 | 0.41 |
| b2 | 0.20 | 0.35 | 0.25 |
| b4 | 0.25REF | | |
| c | 0.230 | 0.330 | 0.277 |
| D | 5.15 BSC | | |
| D1 | 4.70 | 5.10 | 4.90 |
| D2 | 3.56 | 3.96 | 3.76 |
| D2a | 3.78 | 4.18 | 3.98 |
| E | 6.40 BSC | | |
| E1 | 5.60 | 6.00 | 5.80 |
| E2 | 3.46 | 3.86 | 3.66 |
| E2a | 4.195 | 4.595 | 4.395 |
| e | 1.27BSC | | |
| k | 1.05 | -- | -- |
| L | 0.635 | 0.835 | 0.735 |
| La | 0.635 | 0.835 | 0.735 |
| L1 | 0.200 | 0.400 | 0.300 |
| L1a | 0.050REF | | |
| L4 | 0.025 | 0.225 | 0.125 |
| M | 3.205 | 4.005 | 3.605 |
| theta | 10° | 12° | 11° |
| theta1 | 6° | 8° | 7° |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI5060-8 (SWP) (Type UX)



| Dimensions | Value (in mm) |
|------------|------------------|
| C | 1.270 |
| G | 0.660 |
| G1 | 0.820 |
| X | 0.610 |
| X1 | 4.100 |
| X2 | 4.420 |
| Y | 1.270 |
| Y1 | 1.020 |
| Y2 | 3.810 |
| Y3 | 6.610 |

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